## What is claimed is:

- A synchronous flash memory device comprising:

   an array of non-volatile memory cells; and
   a plurality of external connections comprising,
   a plurality of bi-directional data connections,
   a plurality of memory address connections,
   a clock input connection,
   a write enable connection,
   a column address strobe connection, and
   a row address strobe connection.
- 2. The synchronous flash memory device of claim 1, wherein the plurality of external connections further comprises:
  - a clock enable connection,
  - a chip select connection,
  - a plurality of memory array bank address connections,
  - power supply connections,
  - a plurality of data mask connections, and
  - a reset connection.
- 3. The synchronous flash memory device of claim 1, wherein the plurality of external connections further comprises a Vccp power supply connection.
- 4. The synchronous flash memory device of claim 1, further comprising a package having a plurality of interconnect pins corresponding to the external connections.

- 5. The synchronous flash memory device of claim 4, wherein the interconnect pins are physically arranged in a pattern compatible with a synchronous dynamic random access memory (SDRAM).
- The synchronous flash memory device of claim 1, further comprising a package
  having a plurality of conductive interconnect locations corresponding to the external
  connections.
- 7. The synchronous flash memory device of claim 6, wherein the conductive interconnect locations are physically arranged in a pattern compatible with a synchronous dynamic random access memory (SDRAM).
- The synchronous flash memory device of claim 7, wherein the synchronous flash memory device operates within read timing specification parameters for an SDRAM.
- 9. A synchronous flash memory device comprising: an array of non-volatile memory cells; and
  - a package having a plurality of interconnect pins arranged in a manner that corresponds to interconnect pins of a synchronous dynamic random access memory device, wherein the plurality of interconnect pins of the synchronous flash memory device comprises a reset connection, and a Vccp power supply connection correspond to first and second no-connect (NC) interconnect pins of the synchronous dynamic random access memory.
- 10. The synchronous flash memory device of claim 9, wherein the plurality of interconnect pins comprises:
  - a plurality of bi-directional data connections,
  - a plurality of memory address connections,

- a write enable connection,
  a clock input connection,
  a column address strobe connection,
  a row address strobe connection, and
  power supply connections.
- 11. The synchronous flash memory device of claim 10, wherein the plurality of interconnect pins further comprises:
  - a clock enable connection,
  - a chip select connection,
  - a plurality of memory array bank address connections,
  - a plurality of data mask connections,
  - a reset connection, and
  - a Vccp power supply connection.
- 12. A synchronous flash memory device comprising:
  - an array of non-volatile memory cells; and
  - a package having a plurality of solder bump connections arranged in a manner that corresponds to solder bump connections of a synchronous dynamic random access memory device, wherein the plurality of solder bump connections of the synchronous flash memory device comprises a reset connection, and a Vccp power supply connection correspond to first and second no-connect (NC) solder bump connections of the synchronous dynamic random access memory.
- 13. The synchronous flash memory device of claim 12, wherein the plurality of solder bump connections comprises:
  - a plurality of bi-directional data connections,
  - a plurality of memory address connections,
  - a write enable connection,

- a clock input connection,
  a column address strobe connection,
  a row address strobe connection, and
  power supply connections.
- 14. The synchronous flash memory device of claim 13, wherein the plurality of interconnect pins further comprises:
  - a clock enable connection,
  - a chip select connection,
  - a plurality of memory array bank address connections,
  - a plurality of data mask connections,
  - a reset connection, and
  - a Vccp power supply connection.
- 15. A synchronous flash memory device having an interface comprising:
  - a clock input connection (CLK) to receive a clock signal;
  - a write enable connection (WE#) to receive a write enable signal;
  - a column address strobe connection (CAS#) to receive a column address strobe signal;
  - a row address strobe connection (RAS#) to receive a row address strobe signal;
  - a chip select connection (CS#) to receive a chip select signal;
  - a reset connection (RP#) to receive a reset signal; and
  - a Vccp power supply connection to receive an elevated power supply signal.
- 16. The synchronous flash memory device of claim 15, wherein the interface further comprises:
  - a plurality of bi-directional data connections (DQ);
  - a plurality of memory address connections;
  - a clock enable connection (CKE);

a plurality of memory array bank address connections (BA#); power supply connections (Vcc and Vss); and a plurality of data mask connections (DQM).

- 17. The synchronous flash memory device of claim 16, further comprising a package having a plurality of interconnect pins corresponding to the command interface connections.
- 18. The synchronous flash memory device of claim 17, wherein the interconnect pins are physically arranged in a pattern compatible with a synchronous dynamic random access memory (SDRAM).
- 19. The synchronous flash memory device of claim 16, further comprising a package having a plurality of conductive interconnect locations corresponding to the command interface connections.
- 20. The synchronous flash memory device of claim 19, wherein the conductive interconnect locations are physically arranged in a pattern compatible with a synchronous dynamic random access memory (SDRAM).
- 21. A computer system comprising:
  - a memory controller;
  - a main memory bus coupled to the memory controller; and
  - a synchronous non-volatile flash memory device coupled to the main memory bus, wherein the synchronous non-volatile flash memory device has a command interface comprising:
    - a write enable connection (WE#) to receive a write enable signal;
    - a column address strobe connection (CAS#) to receive a column address strobe signal;

- a row address strobe connection (RAS#) to receive a row address strobe signal; and
- a chip select connection (CS#) to receive a chip select signal.
- 22. The computer system of claim 21, wherein the synchronous non-volatile flash memory device comprises a package having a plurality of interconnect pins arranged in a manner that corresponds to interconnect pins of a synchronous dynamic random access memory device, wherein the plurality of interconnect pins of the synchronous flash memory device comprises a reset connection, and a Vccp power supply connection correspond to first and second no-connect (NC) interconnect pins of the synchronous dynamic random access memory.
- 23. The computer system of claim 21, wherein the synchronous non-volatile flash memory device comprises a package having a plurality of solder bump connections arranged in a manner that corresponds to solder bump connections of a synchronous dynamic random access memory device, wherein the plurality of solder bump connections of the synchronous flash memory device comprises a reset connection, and a Vccp power supply connection correspond to first and second no-connect (NC) solder bump connections of the synchronous dynamic random access memory.
- 24. The computer system of claim 21, wherein the synchronous non-volatile flash memory device comprises a plurality of external connections comprising:
  - a plurality of bi-directional data connections;
  - a plurality of memory address connections;
  - a clock input connection;
  - a clock enable connection;
  - a plurality of memory array bank address connections;
  - power supply connections;
  - a plurality of data mask connections;

- a reset connection; and
- a Vccp power supply connection.